

L Number	Hits	Search Text	DB	Time stamp
1	2	("4749120").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 09:23
2	2	("5134460").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/16 09:40
-	3	"5427382"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 14:37
-	15	chang-shyh-ming.in. and (bump ball)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:04
-	16	chang-shyh-ming.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 15:55
-	0	chang-shyh-ming.in. and 08/239,575	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 14:46
-	11	("3401126" "3763550" "3809625" "4749120" "4865245" "4916523" "4963002" "4965227" "5134460" "5298331" "5331235").PN.	USPAT	2003/04/15 14:53
-	0	6365500.URPN.	USPAT	2003/04/15 14:54
-	9	("3401126" "3809625" "4504007" "4883774" "4916523" "4963002" "5115090" "5134460" "5397863").PN.	USPAT	2003/04/15 14:54
-	4	("5393697") or ("5731328").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 15:33
-	3	("6365500") or ("6249051").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:01
-	11	("3401126" "3763550" "3809625" "4749120" "4865245" "4916523" "4963002" "4965227" "5134460" "5298331" "5331235").PN.	USPAT	2003/04/15 15:56
-	9	("3401126" "3809625" "4504007" "4883774" "4916523" "4963002" "5115090" "5134460" "5397863").PN.	USPAT	2003/04/15 15:59
-	1726	257/737-738,778,781,783.ccls. and (bump ball) and pad\$3 and (IC die chip) and substrate	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:04
-	307	257/737-738,778,781,783.ccls. and (bump ball) and pad\$3 and (IC die chip) and substrate and polymer and coat\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:38

-	2	257/737-738,778,781,783.ccls. and (bump ball) with (polyamic adj acid adj polyimide)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:15
-	103	257/737-738,778,781,783.ccls. and (bump ball) with polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:22
-	33	438/614-615.ccls. and (bump ball) with polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:57
-	2	("4749120").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:28
-	2	("4963002").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:43
-	2	("5134460").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:43
-	31	228/180.22.ccls. and (bump ball) with polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 16:58
-	7	jou-jwo-huei.in. and (bump ball) and poly\$4 and coat\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:08
-	7	jou-jwo-huei.in. and (bump ball) and poly\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:08
-	13	Lee-yu-chi.in. and (bump ball) and poly\$4 and coat\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:11
-	4	hu-dyi-chung.in. and (bump ball) and poly\$4 and coat\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:17
-	5	((("4749120") or ("3809625"))).PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:49
-	693	polyamic adj acid adj polyimide	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:52
-	3	(polyamic adj acid adj polyimide) with (bump ball)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/04/15 18:53